

# □ MN101E03G

<b>Type</b>		MN101E03G [ES (Engineering sample available)]	
<b>ROM (×16-bit)</b>		128 K	
<b>RAM (×16-bit)</b>		4 K	
<b>Package</b>		QFP084-P-1818E *Lead-free	
<b>Minimum Instruction Execution Time</b>		100 ns (at 3.135 V to 3.465 V, normal-mode)	
<b>Interrupts</b>		External (7 lines) Internal (13 lines) : Timer × 4, A/D × 1, RESET × 1, OSD × 1, Serial × 2, I <sup>2</sup> C × 1, Caption × 1, Remote control × 1, HSYNC × 1, VSYNC × 1	
<b>Timer Counter</b>		8-bit timer × 4 Watchdog timer: Time-out period is selectable.	
<b>Serial Interface</b>		I <sup>2</sup> C × 1: for multimaster mode, bus line (output) has 2 systems Sync serial / UART × 1	
<b>Caption/Teletext Decoder</b>		• Built-in sync separator × 1	
<b>I/O Pins</b>	<b>I/O</b>	35	• Common use
<b>A/D Inputs</b>		10-bit × 8-ch. (with S/H)	
<b>PWM</b>		8-bit × 6-ch.	
<b>Special Ports</b>		Remote control reception	
<b>CRTC</b>		1-layer display (graphics, characters, splits)	
<b>Notes</b>		Remote control input discriminant circuit built-in, build-in NTSC video signal processing circuit, built-in 3-line comb filter	

Main Content Discontinued

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